

(b) Describe the mechanism of a photo elastic casting. (10)

8. Write short notes on (20)

(a) Brittle coating method

(b) Separation of stress

(c) Gauge sensitivity

Roll No. ....

**22223**

**M. Tech. 1st Semester Mechanical  
Engg. (Machine Design)  
Examination- December, 2016**

**EXPERIMENTAL STRESS ANALYSIS**

**Paper : M-805-A**

**Time : 3 hours**

**Max. Marks : 100**

Before answering the questions, candidates should ensure that they have been supplied the correct and complete question paper. No complaint in this regard will be entertained after the examination.

**Note:** All questions carry equal marks. Attempt any **five** questions.

1. (a) Explain the working of single pressure output pneumatic strain gauge. (10)

(b) Explain with sketch dual-temperature-compensated semiconductor strain gauge. (10)

2. Discuss the various types of bonded type gauges. (20)

3. What is strain gauge sensitive? Explain how strain gauge adhesive is used in strain gauge groups and how the fabrication of gauges is done. Explain. (20)

4. Explain with the help of sketch Potentiometer circuit Wheatstone bridge. (20)

5. (a) Enumerate the properties of an ideal photoelastic material. (10)

(b) Write short note on plane polarized and elliptically polarized light. (10)

6. (a) Explain the working of reflection Polariscope employed to record the birefringence coating data. (10)

(b) Explain any one type of phase mismatch technique. (10)

7. (a) Explain the method calibration of ideal photoelastic material using a circular disc, under diametral compression. (10)